Electronic Patent Application Fee Transmittal							
Application Number:	10	10695187					
Filing Date:	28-Oct-2003						
Title of Invention:	Vertical removal of excess solder from a circuit substrate						
First Named Inventor:	William C. Weigler						
Filer:	Paul M. Hletko/David Hawkins						
Attorney Docket Number:	IS01207AP						
Filed as Large Entity							
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Notice of appeal		1401	1	500	500		
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			500